



#### 20V DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

## **Product Summary**

| V <sub>(BR)DSS</sub> | R <sub>DS(on) max</sub>          | Package | I <sub>D</sub><br>T <sub>A</sub> = +25°C |
|----------------------|----------------------------------|---------|--|
| 20V                  | 25mΩ @ V <sub>GS</sub> = $4.5$ V | SO-8    | 5.8A                                     |
| 200                  | 35m $Ω$ @ V <sub>GS</sub> = 2.5V | 30-6    | 4.8A                                     |

### **Description**

This new generation MOSFET has been designed to minimize the onstate resistance ( $R_{DS(ON)}$ ) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

## **Applications**

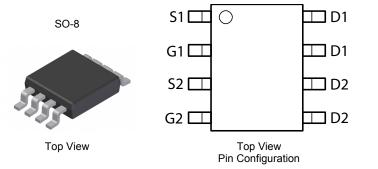
- DC-DC Converters
- Power Management Functions
- Backlighting

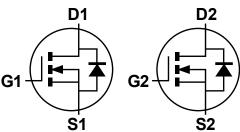
#### **Features**

- Low Input Capacitance
- Low On-Resistance
- · Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Weight: 0.074 grams (approximate)





**Equivalent Circuit** 

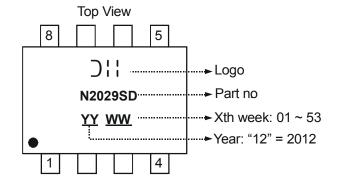
## Ordering Information (Note 4)

| Part Number   | Case | Packaging         |
|---------------|------|-------------------|
| DMN2029USD-13 | SO-8 | 2,500/Tape & Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http"//www.diodes.com/products/packages.html.

## **Marking Information**





## Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic   | Symbol           | Value  | Units            |            |    |
|--|------------------|--|------------------|------------|----|
| Drain-Source Voltage                                     | V <sub>DSS</sub> | 20   | V                |            |    |
| Gate-Source Voltage                                      |                  |  | V <sub>GSS</sub> | ±8         | V  |
| Continuous Dusin Courset (Nata C) V - 4 FV               | Steady<br>State  | T <sub>A</sub> = +25°C<br>T <sub>A</sub> = +70°C | I <sub>D</sub>   | 5.8<br>4.7 | А  |
| Continuous Drain Current (Note 6) V <sub>GS</sub> = 4.5V | t < 10s          | T <sub>A</sub> = +25°C<br>T <sub>A</sub> = +70°C | I <sub>D</sub>   | 6.9<br>5.7 | А  |
| Maximum Body Diode Forward Current (Note 6)              |                  |  | Is               | 2.1        | Α  |
| Pulsed Drain Current (10μs pulse, duty cycle = 1%)       |                  |  | I <sub>DM</sub>  | 30         | Α  |
| Avalanche Current (Note 7) L = 0.1mH                     |                  |  | I <sub>AS</sub>  | 15         | Α  |
| Avalanche Energy (Note 7) L = 0.1mH                      |                  |  | Eas              | 11.2       | mJ |

## Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

| Characteristic                                   | Symbol                 | Value             | Units       |      |
|--|------------------------|-------------------|-------------|------|
| Total Dawar Dissipation (Note 5)                 | T <sub>A</sub> = +25°C | C                 | 1.2         | W    |
| Total Power Dissipation (Note 5)                 | $T_A = +70^{\circ}C$   | $P_{D}$           | 0.7         |      |
| Thermal Decistance Junction to Ambient (Note 5)  | Steady state           | RθJA              | 115         | °C/W |
| Thermal Resistance, Junction to Ambient (Note 5) | t < 10s                | ROJA              | 70          |      |
| Total Power Dissipation (Note 6)                 | $T_A = +25^{\circ}C$   | D-                | 1.4         | W    |
| Total Power Dissipation (Note 6)                 | $T_A = +70^{\circ}C$   | $P_{D}$           | 0.9         |      |
| Thermal Resistance, Junction to Ambient (Note 6) | Steady state           | Б                 | 95          | °C/W |
| Thermal Resistance, Junction to Ambient (Note 6) | t < 10s                | $R_{\theta JA}$   | 60          |      |
| Thermal Resistance, Junction to Case (Note 6)    | $R_{	heta JC}$         | 14.5              |             |      |
| Operating and Storage Temperature Range          |                        | $T_{J_i} T_{STG}$ | -55 to +150 | °C   |

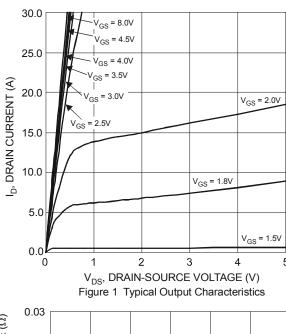
# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

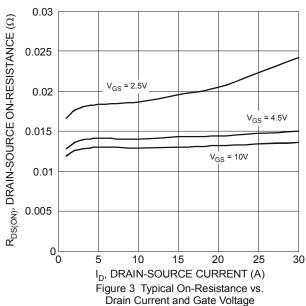
| Characteristic                             | Symbol              | Min | Тур   | Max  | Unit  | Test Condition   |  |
|--|---------------------|-----|-------|------|-------|--|--|
| OFF CHARACTERISTICS (Note 8)               |                     |     |       |      |       |  |  |
| Drain-Source Breakdown Voltage             | BV <sub>DSS</sub>   | 20  | _     | _    | V     | $V_{GS} = 0V, I_D = 250\mu A$  |  |
| Zero Gate Voltage Drain Current            | I <sub>DSS</sub>    | I   | _     | 1    | μA    | $V_{DS} = 16V, V_{GS} = 0V$  |  |
| Gate-Source Leakage                        | I <sub>GSS</sub>    | 1   | _     | ±100 | nA    | $V_{GS} = \pm 8V$ , $V_{DS} = 0V$                                      |  |
| ON CHARACTERISTICS (Note 8)                |                     |     |       |      |       |  |  |
| Gate Threshold Voltage                     | V <sub>GS(th)</sub> | 0.6 | _     | 1.5  | V     | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$                                   |  |
| Static Drain-Source On-Resistance          |                     | 1   | 14    | 25   | mΩ    | $V_{GS} = 4.5V, I_D = 6.5A$  |  |
| Static Dialit-Source Off-Resistance        | R <sub>DS(ON)</sub> | 1   | 19    | 35   | 11177 | $V_{GS} = 2.5V, I_D = 5.4A$  |  |
| Forward Transfer Admittance                | Y <sub>fs</sub>     | ı   | 10    | _    | S     | $V_{DS} = 5V, I_{D} = 6.5A$  |  |
| Diode Forward Voltage                      | $V_{SD}$            | _   | 0.7   | 1.2  | V     | $V_{GS} = 0V, I_{S} = 1.3A$  |  |
| DYNAMIC CHARACTERISTICS (Note 9)           |                     |     |       |      |       |  |  |
| Input Capacitance                          | Ciss                | -   | 1171  | _    |       | V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V<br>f = 1.0MHz              |  |
| Output Capacitance                         | Coss                | _   | 133   | _    | pF    |  |  |
| Reverse Transfer Capacitance               | C <sub>rss</sub>    | _   | 110   | _    |       |  |  |
| Gate Resistance                            | $R_G$               | _   | 1.2   | _    | Ω     | $V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$                                 |  |
| Total Gate Charge (V <sub>GS</sub> = 4.5V) | Qg                  | _   | 10.4  | _    |       | V = 40V L = 24   |  |
| Total Gate Charge (V <sub>GS</sub> = 8V)   | Qg                  | _   | 18.6  | _    | nC    |  |  |
| Gate-Source Charge                         | $Q_{gs}$            | _   | 1.9   | _    | IIC   | $V_{DS} = 10V, I_{D} = 3A$   |  |
| Gate-Drain Charge                          | $Q_{gd}$            | _   | 2.3   | _    |       |  |  |
| Turn-On Delay Time                         | t <sub>D(on)</sub>  | _   | 16.5  | _    |       | $V_{GS}$ = 4.5V, $V_{DD}$ = 10V, $R_{GEN}$ = 6 $\Omega$ , $I_{D}$ = 1A |  |
| Turn-On Rise Time                          | t <sub>r</sub>      | _   | 33.3  | _    | nS    |  |  |
| Turn-Off Delay Time                        | $t_{D(off)}$        | _   | 119.3 | _    | 110   |  |  |
| Turn-Off Fall Time                         | t <sub>f</sub>      | _   | 53.5  | _    |       |  |  |
| Body Diode Reverse Recovery Time           | t <sub>rr</sub>     | _   | 7.5   | _    | nS    | I <sub>S</sub> = 6.5A, dl/dt = 100A/µs                                 |  |
| Body Diode Reverse Recovery Charge         | Q <sub>rr</sub>     |     | 2.0   | _    | nC    | I <sub>S</sub> = 6.5A, dI/dt = 100A/µs                                 |  |

Notes:

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
- 7.  $I_{AR}$  and  $E_{AR}$  rating are based on low frequency and duty cycles to keep  $T_J$  = +25°C 8. Short duration pulse test used to minimize self-heating effect.
- 9. Guaranteed by design. Not subject to product testing.







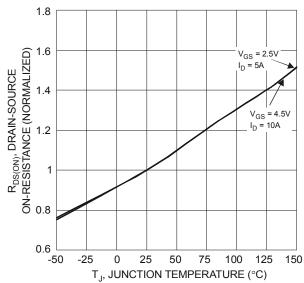
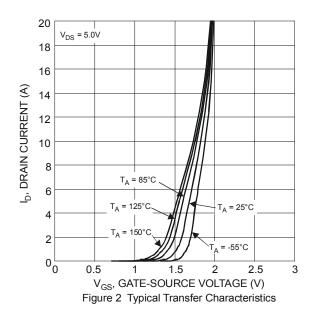
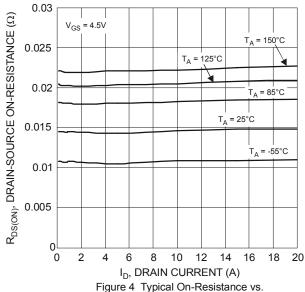


Figure 5 On-Resistance Variation with Temperature





0.04  $R_{DS(ON)}$ , DRAIN-SOURCE ON-RESISTANCE  $(\Omega)$ 0.03  $V_{GS} = 2.5V$   $I_D = 5A$  $I_D$ 0.02  $V_{GS} = 4.5V$   $I_D = 10A$ 0.01 25 75 -50 -25 0 50 100 125 T<sub>J</sub>, JUNCTION TEMPERATURE (°C)

Drain Current and Temperature

Figure 6 On-Resistance Variation with Temperature



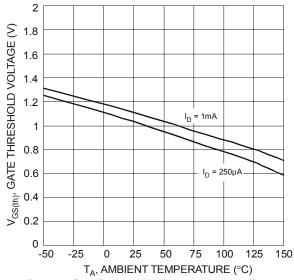
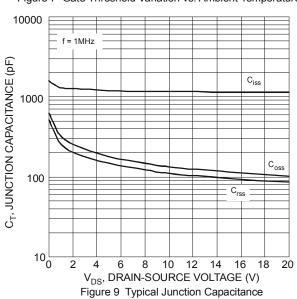
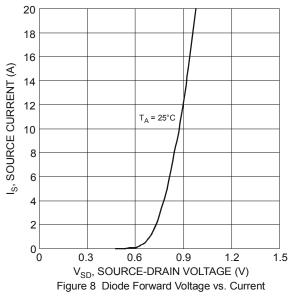
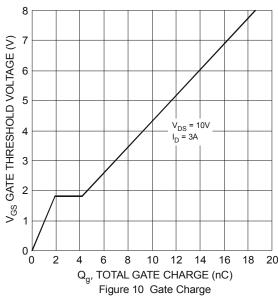


Figure 7 Gate Threshold Variation vs. Ambient Temperature







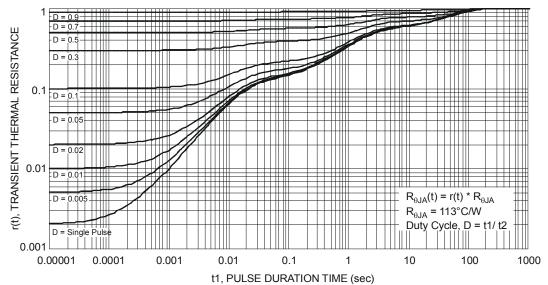
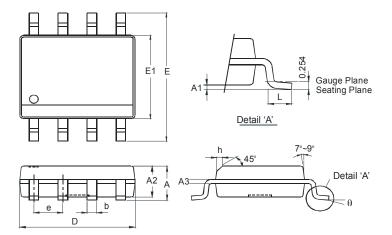


Figure 11 Transient Thermal Resistance



# **Package Outline Dimensions**

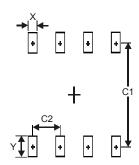
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



| SO-8                 |          |      |  |  |
|----------------------|----------|------|--|--|
| Dim                  | Min      | Max  |  |  |
| Α                    | ı        | 1.75 |  |  |
| A1                   | 0.10     | 0.20 |  |  |
| A2                   | 1.30     | 1.50 |  |  |
| A3                   | 0.15     | 0.25 |  |  |
| b                    | 0.3      | 0.5  |  |  |
| D                    | 4.85     | 4.95 |  |  |
| Е                    | 5.90     | 6.10 |  |  |
| E1                   | 3.85     | 3.95 |  |  |
| е                    | 1.27 Typ |      |  |  |
| h                    | -        | 0.35 |  |  |
| ٦                    | 0.62     | 0.82 |  |  |
| θ                    | 0°       | 8°   |  |  |
| All Dimensions in mm |          |      |  |  |

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) |  |  |
|------------|---------------|--|--|
| X          | 0.60          |  |  |
| Υ          | 1.55          |  |  |
| C1         | 5.4           |  |  |
| C2         | 1.27          |  |  |



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